## 300-OUTPUT TFT-LCD SOURCE DRIVER (COMPATIBLE WITH 64 GRAY SCALE)

## DESCRIPTION

The $\mu$ PD16634A is a source driver for TFT-LCDs capable of dealing with displays 64 gray scales. Data input is based on digital input configured as 6 bits by 6 dots ( 2 pixels), which can realize a full-color display of 260,000 colors by output of 64 values $\gamma$-corrected by an internal D/A converter and 5 -by- 2 external power modules. Because the
$\star$ output dynamic range is as large as $\mathrm{Vss} 2+0.1 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD} 2}-0.1 \mathrm{~V}$, level inversion operation of the LCD's common electrode is rendered unnecessary. Also to be able to deal with dot-line inversion when mounted on a single side, this source driver equipped with a built-in 6-bit D/A converter circuit whose odd output pins and even output pins respectively output gray scale voltages of differing polarity. Assuring a maximum clock frequent of 40 MHz when drivng at 3.0 V , this driver is applicable to XGA-standard TFT-LCD panels.

## FEATURES

- 300 outputs
- CMOS level input
- Input of 6 bits (gradation data) by 6 dots
- Capable of outputting 64 values by means of 5-by-2 external power modules ( 10 units) and a D/A converter
* • Output dynamic range : Vss2+0.1 V to VdD2-0.1 V
$\star$ - Logic part supply voltage (VDD1) : 3.3 V $\pm 0.3 \mathrm{~V}$
$\star$ - Driver part supply voltage (VDD2) : 8.0 V $\pm 0.5 \mathrm{~V}$
- High-speed data transfer: fmax=40 MHz MIN.(internal data transfer rate when operating at 3.0 V )
- Output voltage polarity inversion is possible (POL)
- Display data inversion function (POL2)
- Single bank arrangement is possible(loaded with slim TCP).


## ORDERING INFORMATION

| Part Number | Package |
| :---: | :---: |
| $\mu$ PD16634AN-xxx | TCP (TAB package) |

Remark The TCP's external shape is customized. To order your TCP's external shape, please contact a NEC salesperson.

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 confirm that this is the latest version.Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

## 1. BLOCK DIAGRAM



Remark /xxx indicates active low signal.
^ 2. RELATIONSHIP BETWEEN OUTPUT CIRCUIT AND D/A CONVERTER


## 3. PIN CONFIGURATION ( $\mu$ PD16634AN-xxx)



Caution This figure does not specify the TCP package. Therefore POL2 pins can be reduced by opening or short-circuiting to Vss2 by TCP wiring. POL2 pin can short to Vss1 on TCP. So when you not use "data inversion function", can reduce input pins.

## 4. PIN FUNCTIONS

| Pin Symbol | Pin Name | Description |
| :---: | :---: | :---: |
| $\mathrm{S}_{1}$ to $\mathrm{S}_{300}$ | Driver output | The D/A converted 64-gray-scale analog voltage is output |
| D00 to D05 | Display data input | The display data is input with a width of 36 bits, viz., the gray scale data (6 bits) by 6 dots (2 pixels). <br> Dxo: LSB, Dx5: MSB |
| $\mathrm{D}_{10}$ to $\mathrm{D}_{15}$ |  |  |
| $\mathrm{D}_{20}$ to $\mathrm{D}_{25}$ |  |  |
| D30 to D35 |  |  |
| D40 to D45 |  |  |
| $\mathrm{D}_{50}$ to D ${ }_{55}$ |  |  |
| R,/L | Shift direction switching input | These refer to the start pulse input/output pins when cascades are connected. The shift directions of the shift registers are as follows. $R, / L=H: S T H R$ input, $S_{1} \rightarrow S_{300}$, STHL output <br> $R, / L=L: S T H L$ input, $S_{300} \rightarrow S_{1}$, STHR output |
| STHR | Right shift start pulse input/output | $R, / L=H$ : Becomes the start pulse input pin. <br> $R, / L=L$ : Becomes the start pulse output pin. |
| STHL | Left shift start pulse input/output | $R, / L=H$ : Becomes the start pulse input pin. <br> $R, / L=L$ : Becomes the start pulse output pin. |
| CLK | Shift clock input | Refers to the shift register's shift clock input. The display data is incorporated into the data register at the rising edge. At the rising edge of the 50th clock after the start pulse input, the start pulse output reaches the high level, thus becoming the start pulse of the next-level driver. The initiallevel driver's 50th clock becomes valid as the next-level driver's start pulse is input. If 52 clock pulses are input after input of the start pulse, input of display data is halted automatically. The contents of the shift register are cleared at the STB's rising edge. |
| STB | Latch input | The contents of the data register are transferred to the latch at the rising edge. And, at the falling edge, the gray scale voltage is supplied to the driver. It is necessary to ensure input of one pulse per horizontal period. |
| POL | Polarity input | $\mathrm{POL}=\mathrm{L}$; The $\mathrm{S}_{2 n-1}$ output uses $\mathrm{V}_{0}$ to $\mathrm{V}_{4}$ as the reference supply; and the $\mathrm{S}_{2 n}$ output uses $\mathrm{V}_{5}$ to $\mathrm{V}_{9}$ as the reference supply. <br> POL $=\mathrm{H}$; The $\mathrm{S}_{2 n-1}$ output uses $\mathrm{V}_{5}$ to $\mathrm{V}_{9}$ as the reference supply; and the $\mathrm{S}_{2 n}$ output uses $\mathrm{V}_{0}$ to $\mathrm{V}_{4}$ as the reference supply. <br> $\mathrm{S}_{2 n-1}$ indicates the odd output; and $\mathrm{S}_{2 n}$ indicates the even output. Input of the POL signal is allowed the setup time (tpol-stв) with respect to STB's rising edge. |
| POL2 | Data inversion input | POL2 $=\mathrm{H}$ : Display data is inverted. <br> POL2 $=\mathrm{L}$ : Display data is not inverted. |
| $\mathrm{V}_{0}$ to $\mathrm{V}_{9}$ | $\gamma$-corrected power supplies | Input the $\gamma$-corrected power supplies from outside by using operational amplifier. Make sure to maintain the following relationships. During the gray scale voltage output, be sure to keep the gray scale level power supply at a constant level. $\mathrm{V}_{\mathrm{DD} 2}>\mathrm{V}_{0}>\mathrm{V}_{1}>\mathrm{V}_{2}>\mathrm{V}_{3}>\mathrm{V}_{4}>\mathrm{V}_{5}>\mathrm{V}_{6}>\mathrm{V}_{7}>\mathrm{V}_{8}>\mathrm{V}_{9}>\mathrm{V}_{\mathrm{SS} 2}$ |
| TEST | Test pin | Set it to open. |
| VDD1 | Logic circuit power supply | $3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ |
| VDD2 | Driver circuit power supply | $8.0 \mathrm{~V} \pm 0.5 \mathrm{~V}$ |
| Vss1 | Logic ground | Grounding |
| Vss2 | Driver ground | Grounding |

Cautions 1. The power start sequence must be $V_{D D 1}$, logic input, and $V_{D D 2} \& V_{0}$ to $V_{9}$ in that order. Reverse this sequence to shut down.(Simultaneous power application to $V_{d d 2}$ and $V_{0}$ to $V_{9}$ is possible.)
2. To stabilize the supply voltage, please be sure to insert $0.1 \mu \mathrm{~F}$ bypass capacitor between $V_{D D 1}-V_{s s 1}$ and $V_{D D 2}-V_{s S 2}$. Furthermore, for increase precision of the $\mathrm{D} / \mathrm{A}$ converter, insertion of a bypass capacitor of about $0.01 \mu \mathrm{~F}$ is also advised between the $\boldsymbol{\gamma}$-corrected power supply terminals( $\left.\mathrm{V}_{0}, \mathrm{~V}_{1}, \mathrm{~V}_{2} \ldots, \mathrm{~V}_{9}\right)$ and $\mathrm{Vsss}^{2}$.
3. We recommend to use Operational Amplifier to lower input impedance of $\boldsymbol{\gamma}$ corrected voltage.

## 5. RELATIONHIP BETWEEN INPUT DATA AND OUTPUT VOLTAGE VALUE

This product incorporates a 6-bit D/A converter whose odd output pins and even output pins output respectively gray scale voltages of differing polarity with respect to the LCD's counter electrode (common electrode) voltage. The D/A converter consists of ladder resistors and switches. The ladder resistors ro to r62 are so designed that the ratios between the LCD panel's $\gamma$-corrected voltages and $\mathrm{V}_{0}$ ' to $\mathrm{V}_{63}$ ', $\mathrm{V}_{0}$ " to $\mathrm{V}_{63}$ " are roughly equal; and their respective resistance values are as shown in Table 6-1. Among the 5 -by $2 \gamma$-corrected voltages, input gray scale voltages of the same polarity with respect to the common voltage, for the respective five $\gamma$-corrected voltages of $\mathrm{V}_{0}$ to $\mathrm{V}_{4}$ and $\mathrm{V}_{5}$ to $V_{9}$. If fine gray scale voltage precision is not necessary, the voltage follower circuit supplied to the $\gamma$-corrected power supplies $\mathrm{V}_{1}$ to $\mathrm{V}_{3}$ and $\mathrm{V}_{6}$ to $\mathrm{V}_{8}$ can be deleted.
Figure $5-1$ shows the relationship between the driving voltages such as liquid-crystal driving voltages VdD2 and Vss2, common electrode potential $\mathrm{V}_{\text {сом, }}$, and $\gamma$-corrected voltages $\mathrm{V}_{0}$ to $\mathrm{V}_{9}$ and the input data. Be sure to maintain the voltage relationships of $V_{D D 2}>V_{0}>V_{1}>V_{2}>V_{3}>V_{4}>V_{5}>V_{6}>V_{7}>V_{8}>V_{9}>V_{s s 2}$. Figure 6-1 and 6-2 show the relationship between the input data and the output data.
This driver IC is designed for single-sided mounting. Therefore, please do not use it for $\gamma$-corrected power supply level inversion in double-sided mounting.

Figure 5-1. Relationship between Input Data and Output Voltage


## 6. RESISTOR STRINGS

Figure 6-1. Relationship Between Input Data and Output Voltage : $\mathrm{V}_{\mathrm{DD} 2}>\mathrm{V}_{0}>\mathrm{V}_{1}>\mathrm{V}_{2}>\mathrm{V}_{3}>\mathrm{V}_{4}>\mathrm{V}_{5}$, POL2 $=\mathrm{L}$


| Data | Dx5 | Dx4 | Dх3 | Dx2 | Dx1 | Dxo | Output Voltage |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 00H | 0 | 0 | 0 | 0 | 0 | 0 | Vo, | $\mathrm{V}_{0}$ |
| 01H | 0 | 0 | 0 | 0 | 0 | 1 | $V_{1}{ }^{\prime}$ | $\mathrm{V}_{1}+\left(\mathrm{V}_{0}-\mathrm{V}_{1}\right) \times 7250 / 8050$ |
| 02H | 0 | 0 | 0 | 0 | 1 | 0 | $\mathrm{V}_{2}{ }^{\prime}$ | $\mathrm{V}_{1}+\left(\mathrm{V}_{0}-\mathrm{V}_{1}\right) \times 6500 / 8050$ |
| 03H | 0 | 0 | 0 | 0 | 1 | 1 | $V_{3}{ }^{\prime}$ | $\mathrm{V}_{1}+\left(\mathrm{V}_{0}-\mathrm{V}_{1}\right) \times 5800 / 8050$ |
| 04H | 0 | 0 | 0 | 1 | 0 | 0 | $\mathrm{V}_{4}{ }^{\prime}$ | $\mathrm{V}_{1}+\left(\mathrm{V}_{0}-\mathrm{V}_{1}\right) \times 5150 / 8050$ |
| 05H | 0 | 0 | 0 | 1 | 0 | 1 | $V_{5}{ }^{\prime}$ | $\mathrm{V}_{1}+\left(\mathrm{V}_{0}-\mathrm{V}_{1}\right) \times 4550 / 8050$ |
| 06H | 0 | 0 | 0 | 1 | 1 | 0 | V6' | $\mathrm{V}_{1}+\left(\mathrm{V}_{0}-\mathrm{V}_{1}\right) \times 4000 / 8050$ |
| 07H | 0 | 0 | 0 | 1 | 1 | 1 | $V_{7}{ }^{\prime}$ | $\mathrm{V}_{1}+\left(\mathrm{V}_{0}-\mathrm{V}_{1}\right) \times 3450 / 8050$ |
| 08H | 0 | 0 | 1 | 0 | 0 | 0 | $\mathrm{V}_{8}{ }^{\prime}$ | $\mathrm{V}_{1}+\left(\mathrm{V}_{0}-\mathrm{V}_{1}\right) \times 2950 / 8050$ |
| 09H | 0 | 0 | 1 | 0 | 0 | 1 | V9' | $V_{1}+\left(V_{0}-V_{1}\right) \times 2450 / 8050$ |
| OAH | 0 | 0 | 1 | 0 | 1 | 0 | $\mathrm{V}_{10}{ }^{\prime}$ | $\mathrm{V}_{1}+\left(\mathrm{V}_{0}-\mathrm{V}_{1}\right) \times 2050 / 8050$ |
| OBH | 0 | 0 | 1 | 0 | 1 | 1 | $\mathrm{V}_{11}{ }^{\prime}$ | $\mathrm{V}_{1}+\left(\mathrm{V}_{0}-\mathrm{V}_{1}\right) \times 1650 / 8050$ |
| OCH | 0 | 0 | 1 | 1 | 0 | 0 | $\mathrm{V}_{12}{ }^{\prime}$ | $\mathrm{V}_{1}+\left(\mathrm{V}_{0}-\mathrm{V}_{1}\right) \times 1300 / 8050$ |
| ODH | 0 | 0 | 1 | 1 | 0 | 1 | $\mathrm{V}_{13}{ }^{\prime}$ | $\mathrm{V}_{1}+\left(\mathrm{V}_{0}-\mathrm{V}_{1}\right) \times 950 / 8050$ |
| OEH | 0 | 0 | 1 | 1 | 1 | 0 | $\mathrm{V}_{14}{ }^{\prime}$ | $\mathrm{V}_{1}+\left(\mathrm{V}_{0}-\mathrm{V}_{1}\right) \times 600 / 8050$ |
| OFH | 0 | 0 | 1 | 1 | 1 | 1 | $\mathrm{V}_{15}{ }^{\prime}$ | $\mathrm{V}_{1}+\left(\mathrm{V}_{0}-\mathrm{V}_{1}\right) \times 300 / 8050$ |
| 10H | 0 | 1 | 0 | 0 | 0 | 0 | $\mathrm{V}_{16}{ }^{\prime}$ | $\mathrm{V}_{1}$ |
| 11H | 0 | 1 | 0 | 0 | 0 | 1 | $\mathrm{V}_{17}{ }^{\prime}$ | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 2450 / 2750$ |
| 12 H | 0 | 1 | 0 | 0 | 1 | 0 | $\mathrm{V}_{18}{ }^{\prime}$ | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 2200 / 2750$ |
| 13H | 0 | 1 | 0 | 0 | 1 | 1 | $\mathrm{V}_{19}{ }^{\prime}$ | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 1950 / 2750$ |
| 14H | 0 | 1 | 0 | 1 | 0 | 0 | $\mathrm{V}_{20}{ }^{\prime}$ | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 1700 / 2750$ |
| 15H | 0 | 1 | 0 | 1 | 0 | 1 | $\mathrm{V}_{21}{ }^{\prime}$ | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 1500 / 2750$ |
| 16H | 0 | 1 | 0 | 1 | 1 | 0 | $\mathrm{V}_{22}{ }^{\prime}$ | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 1300 / 2750$ |
| 17H | 0 | 1 | 0 | 1 | 1 | 1 | $\mathrm{V}_{23}{ }^{\prime}$ | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 1100 / 2750$ |
| 18H | 0 | 1 | 1 | 0 | 0 | 0 | $\mathrm{V}_{24}{ }^{\prime}$ | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 950 / 2750$ |
| 19H | 0 | 1 | 1 | 0 | 0 | 1 | $\mathrm{V}_{25}{ }^{\prime}$ | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 800 / 2750$ |
| 1 AH | 0 | 1 | 1 | 0 | 1 | 0 | $\mathrm{V}_{26}{ }^{\prime}$ | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 650 / 2750$ |
| 1BH | 0 | 1 | 1 | 0 | 1 | 1 | $\mathrm{V}_{27}{ }^{\prime}$ | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 500 / 2750$ |
| 1 CH | 0 | 1 | 1 | 1 | 0 | 0 | $\mathrm{V}_{28}{ }^{\prime}$ | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 400 / 2750$ |
| 1DH | 0 | 1 | 1 | 1 | 0 | 1 | V 29 ' | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 300 / 2750$ |
| 1EH | 0 | 1 | 1 | 1 | 1 | 0 | $\mathrm{V}_{30}{ }^{\prime}$ | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 200 / 2750$ |
| 1 FH | 0 | 1 | 1 | 1 | 1 | 1 | $\mathrm{V}_{31}{ }^{\prime}$ | $\mathrm{V}_{2}+\left(\mathrm{V}_{1}-\mathrm{V}_{2}\right) \times 100 / 2750$ |
| 20 H | 1 | 0 | 0 | 0 | 0 | 0 | $\mathrm{V}_{32}{ }^{\prime}$ | $\mathrm{V}_{2}$ |
| 21 H | 1 | 0 | 0 | 0 | 0 | 1 | $\mathrm{V}_{33}{ }^{\prime}$ | $V_{3}+\left(V_{2}-V_{3}\right) \times 1500 / 1600$ |
| 22 H | 1 | 0 | 0 | 0 | 1 | 0 | $\mathrm{V}_{34}{ }^{\prime}$ | $V_{3}+\left(V_{2}-V_{3}\right) \times 1400 / 1600$ |
| 23 H | 1 | 0 | 0 | 0 | 1 | 1 | $\mathrm{V}_{35}{ }^{\prime}$ | $\mathrm{V}_{3}+\left(\mathrm{V}_{2}-\mathrm{V}_{3}\right) \times 1300 / 1600$ |
| 24 H | 1 | 0 | 0 | 1 | 0 | 0 | $V_{36}{ }^{\prime}$ | $V_{3}+\left(V_{2}-V_{3}\right) \times 1200 / 1600$ |
| 25 H | 1 | 0 | 0 | 1 | 0 | 1 | $V_{37}{ }^{\prime}$ | $V_{3}+\left(V_{2}-V_{3}\right) \times 1100 / 1600$ |
| 26 H | 1 | 0 | 0 | 1 | 1 | 0 | $V_{38}{ }^{\prime}$ | $\mathrm{V}_{3}+\left(V_{2}-V_{3}\right) \times 1000 / 1600$ |
| 27H | 1 | 0 | 0 | 1 | 1 | 1 | $\mathrm{V}_{39}{ }^{\prime}$ | $V_{3}+\left(V_{2}-V_{3}\right) \times 900 / 1600$ |
| 28H | 1 | 0 | 1 | 0 | 0 | 0 | $\mathrm{V}_{40}{ }^{\prime}$ | $\mathrm{V}_{3}+\left(\mathrm{V}_{2}-\mathrm{V}_{3}\right) \times 800 / 1600$ |
| 29 H | 1 | 0 | 1 | 0 | 0 | 1 | $\mathrm{V}_{41}{ }^{\prime}$ | $V_{3}+\left(V_{2}-V_{3}\right) \times 700 / 1600$ |
| 2 AH | 1 | 0 | 1 | 0 | 1 | 0 | $V_{42}{ }^{\prime}$ | $\mathrm{V}_{3}+\left(\mathrm{V}_{2}-\mathrm{V}_{3}\right) \times 600 / 1600$ |
| 2BH | 1 | 0 | 1 | 0 | 1 | 1 | $V_{43}{ }^{\prime}$ | $V_{3}+\left(V_{2}-V_{3}\right) \times 500 / 1600$ |
| 2 CH | 1 | 0 | 1 | 1 | 0 | 0 | $\mathrm{V}_{44}{ }^{\prime}$ | $\mathrm{V}_{3}+\left(\mathrm{V}_{2}-\mathrm{V}_{3}\right) \times 400 / 1600$ |
| 2DH | 1 | 0 | 1 | 1 | 0 | 1 | $\mathrm{V}_{45}{ }^{\prime}$ | $V_{3}+\left(V_{2}-V_{3}\right) \times 300 / 1600$ |
| 2EH | 1 | 0 | 1 | 1 | 1 | 0 | $\mathrm{V}_{46}{ }^{\prime}$ | $V_{3}+\left(V_{2}-V_{3}\right) \times 200 / 1600$ |
| 2 FH | 1 | 0 | 1 | 1 | 1 | 1 | $\mathrm{V}_{47}{ }^{\prime}$ | $V_{3}+\left(V_{2}-V_{3}\right) \times 100 / 1600$ |
| 30 H | 1 | 1 | 0 | 0 | 0 | 0 | $\mathrm{V}_{48}{ }^{\prime}$ | $V_{3}$ |
| 31 H | 1 | 1 | 0 | 0 | 0 | 1 | $\mathrm{V}_{49}{ }^{\prime}$ | $V_{4}+\left(V_{3}-V_{4}\right) \times 3350 / 3450$ |
| 32 H | 1 | 1 | 0 | 0 | 1 | 0 | $\mathrm{V}_{50}{ }^{\prime}$ | $V_{4}+\left(V_{3}-V_{4}\right) \times 3250 / 3450$ |
| 33 H | 1 | 1 | 0 | 0 | 1 | 1 | $\mathrm{V}_{51}$ ' | $V_{4}+\left(V_{3}-V_{4}\right) \times 3150 / 3450$ |
| 34 H | 1 | 1 | 0 | 1 | 0 | 0 | $\mathrm{V}_{52}{ }^{\prime}$ | $\mathrm{V}_{4}+\left(\mathrm{V}_{3}-\mathrm{V}_{4}\right) \times 3050 / 3450$ |
| 35 H | 1 | 1 | 0 | 1 | 0 | 1 | $\mathrm{V}_{53}{ }^{\prime}$ | $\mathrm{V}_{4}+\left(\mathrm{V}_{3}-\mathrm{V}_{4}\right) \times 2950 / 3450$ |
| 36 H | 1 | 1 | 0 | 1 | 1 | 0 | $\mathrm{V}_{54}{ }^{\prime}$ | $\mathrm{V}_{4}+\left(\mathrm{V}_{3}-\mathrm{V}_{4}\right) \times 2800 / 3450$ |
| 37H | 1 | 1 | 0 | 1 | 1 | 1 | $V_{55}{ }^{\prime}$ | $V_{4}+\left(V_{3}-V_{4}\right) \times 2650 / 3450$ |
| 38 H | 1 | 1 | 1 | 0 | 0 | 0 | $\mathrm{V}_{56}{ }^{\prime}$ | $\mathrm{V}_{4}+\left(\mathrm{V}_{3}-\mathrm{V}_{4}\right) \times 2500 / 3450$ |
| 39 H | 1 | 1 | 1 | 0 | 0 | 1 | $\mathrm{V}_{57}{ }^{\prime}$ | $\mathrm{V}_{4}+\left(\mathrm{V}_{3}-\mathrm{V}_{4}\right) \times 2300 / 3450$ |
| 3AH | 1 | 1 | 1 | 0 | 1 | 0 | $\mathrm{V}_{58}{ }^{\prime}$ | $\mathrm{V}_{4}+\left(\mathrm{V}_{3}-\mathrm{V}_{4}\right) \times 2100 / 3450$ |
| 3BH | 1 | 1 | 1 | 0 | 1 | 1 | $\mathrm{V}_{59}{ }^{\prime}$ | $V_{4}+\left(V_{3}-V_{4}\right) \times 1850 / 3450$ |
| 3 CH | 1 | 1 | 1 | 1 | 0 | 0 | V60' | $V_{4}+\left(V_{3}-V_{4}\right) \times 1600 / 3450$ |
| 3DH | 1 | 1 | 1 | 1 | 0 | 1 | $\mathrm{V}_{61}{ }^{\prime}$ | $\mathrm{V}_{4}+\left(\mathrm{V}_{3}-\mathrm{V}_{4}\right) \times 1300 / 3450$ |
| 3EH | 1 | 1 | 1 | 1 | 1 | 0 | $V_{62}{ }^{\prime}$ | $\mathrm{V}_{4}+\left(\mathrm{V}_{3}-\mathrm{V}_{4}\right) \times 800 / 3450$ |
| 3FH | 1 | 1 | 1 | 1 | 1 | 1 | $\mathrm{V}_{63}{ }^{\prime}$ | $V_{4}$ |

Figure 6-2. Relationship Between Input Data and Output Voltage: $V_{4}>V_{5}>V_{6}>V_{7}>V_{8}>V_{9}>V_{s s 2}$, POL2 $=L$


Table 6-1. Ladder Resistance Values (ro to r62) : Reference Value


## 7. RELATIONSHIP BETWEEN INPUT DATA AND OUTPUT PIN

Data format: 6 bits $\times 2$ RGBs ( 6 dots)
Input width : 36 bits (2-pixel data)
(1) $R, / L=H$ (right shift)

| Output | $S_{1}$ | $S_{2}$ | $S_{3}$ | $S_{4}$ | $S_{5}$ | $\ldots$ | $S_{299}$ | $S_{300}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Data | $D_{00}$ to $D_{05}$ | $D_{10}$ to $D_{15}$ | $D_{20}$ to $D_{25}$ | $D_{30}$ to $D_{35}$ | $D_{40}$ to $D_{45}$ | $\ldots$ | $D_{40}$ to $D_{45}$ | $D_{50}$ to $D_{55}$ |

(2) $R, / L=L$ (left shift)

| Output | $S_{1}$ | $S_{2}$ | $S_{3}$ | $S_{4}$ | $S_{5}$ | $\ldots$ | $S_{299}$ | $S_{300}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Data | $D_{00}$ to $D_{05}$ | $D_{10}$ to $D_{15}$ | $D_{20}$ to $D_{25}$ | $D_{30}$ to $D_{35}$ | $D_{40}$ to $D_{45}$ | $\ldots$ | $D_{40}$ to $D_{45}$ | $D_{50}$ to $D_{55}$ |


| POL | $\mathrm{S}_{2 n-1}$ | $\mathrm{~S}_{2 n}$ |
| :---: | :---: | :---: |
| L | $\mathrm{~V}_{0}$ to $\mathrm{V}_{4}$ | $\mathrm{~V}_{5}$ to $\mathrm{V}_{9}$ |
| H | $\mathrm{V}_{5}$ to $\mathrm{V}_{9}$ | $\mathrm{~V}_{0}$ to $\mathrm{V}_{4}$ |

Remark $\mathrm{S}_{2 n-1}$ (Odd output), S2n (Even output)n $=1,2, \ldots \ldots . ., 150$

## 8. RELATIONSHIP BETWEEN STB, POL, AND OUTPUT WAVEFORM

The output voltage is written to the LCD panel synchronized with the STB falling edge.


## 9. CAUTIONS ABOUT FRAME INVERSION

In the case of dot inversion, $n$ frame last line and $(n+1)$ frame first line is the same polarity. When write the same polarity twice; there are two cases as follows.
(1) Last line output in $n$ frame $>$ First line output in $(n+1)$ frame $\rightarrow$ Positive to write
(2) Last line output in $n$ frame < First line output in $(n+1)$ frame $\rightarrow$ Not possible to write
$\mu$ PD16634A has charge buffer and discharge buffer, so need to inversion polarity and write in the case of both ways.


## 10. ELECTRICAL SPECIFICATIONS

Absolute Maximum Ratings ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{ss} 1}=\mathrm{V}_{\mathrm{ss} 2}=0 \mathrm{~V}$ )

| Parameter | Symbol | Ratings | Unit |
| :---: | :---: | :---: | :---: |
| Logic part supply voltage | VDD1 | -0.5 to +5.0 | V |
| Driver part supply voltage | VDD2 | -0.5 to +10.0 | V |
| Logic part input voltage | $\mathrm{V}_{11}$ | -0.5 to $\mathrm{VDD}^{+}+0.5$ | V |
| Driver part input voltage | $V_{12}$ | -0.5 to $\mathrm{VDD2}^{+}+0.5$ | V |
| Logic part output voltage | Vo1 | -0.5 to $\mathrm{VDD}^{+}+0.5$ | V |
| Driver part output voltage | Vo2 | -0.5 to VDD2 +0.5 | V |
| Operating ambient temperature | TA | -10 to +75 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature | $\mathrm{T}_{\text {stg }}$ | -55 to +125 | ${ }^{\circ} \mathrm{C}$ |

$\star$ Caution If the absolute maximum rating of even one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.

Recommended Operating Range ( $\mathrm{T}_{\mathrm{A}}=\mathbf{- 1 0}$ to $+\mathbf{7 5}{ }^{\circ} \mathrm{C}, \mathrm{Vss} 1=\mathrm{V}_{\mathrm{ss} 2}=\mathbf{0} \mathrm{V}$ )

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Logic part supply voltage | VDD1 | 3.0 | 3.3 | 3.6 | V |
| Driver part supply voltage | VDD2 | 7.5 | 8.0 | 8.5 | V |
| High-level input voltage | VIH | $0.7 \mathrm{~V}_{\text {dD } 1}$ |  | VDD1 | V |
| Low-level input voltage | VIL | 0 |  | 0.3V ${ }_{\text {DD1 }}$ | V |
| $\gamma$-corrected supply voltage | Vo to $\mathrm{V}_{9}$ | Vss2 |  | VDD2 | V |
| Driver part output voltage | Vo | Vss2 +0.1 |  | VdD2 - 0.1 | V |
| Maximum clock frequency | fmax. | 40 |  |  | MHz |

Electrical Characteristics ( $\mathrm{T}_{\mathrm{A}}=-10$ to $+75^{\circ} \mathrm{C}, \mathrm{VdD} 1=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{dD} 2}=8.0 \mathrm{~V} \pm 0.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{ss} 1}=\mathrm{V}_{\mathrm{ss} 2}=0 \mathrm{~V}$ )

| Parameter | Symbol | Condition |  | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input leakage current | ILL |  |  |  |  | $\pm 1.0$ | $\mu \mathrm{A}$ |
| High-level output voltage | Vон | STHR(STHL), $\mathrm{lo}=0 \mathrm{~mA}$ |  | VDD1-0.1 |  |  | V |
| Low-level output voltage | Vol | STHR(STHL), lo=0 mA |  |  |  | 0.1 | V |
| $\gamma$-corrected supply current | $\mathrm{I}_{\gamma}$ | $\mathrm{V}_{0}-\mathrm{V}_{9}=8 \mathrm{~V}$ | $\mathrm{V}_{0}, \mathrm{~V}_{9}$ |  | 0.3 | 0.6 | mA |
| Driver output current | Ivoh | $\mathrm{V}=7 \mathrm{~V}$, Vout $=1 \mathrm{~V}^{\text {Note } 1}$ |  |  |  | -0.5 | mA |
|  | Ivol | $\mathrm{V} x=1 \mathrm{~V}$, Vout=7 $\mathrm{V}^{\text {Note1 }}$ |  | 0.5 |  |  | mA |
| Output voltage deviation ${ }^{\text {Note2 }}$ | $\Delta \mathrm{V}$ o | Input data : 00 H to 3FH |  |  | $\pm 5$ | $\pm 20$ | mV |
| Average output voltage variation ${ }^{\text {Note3 }}$ | $\Delta \mathrm{V}_{\mathrm{AV}}$ | Input data : 00 H to 3FH |  |  | $\pm 10$ |  | mV |
| Output voltage range | Vo | Input data : 00 H to 3FH |  | 0.1 |  | V ${ }_{\text {dD2-0.1 }}$ | V |
| Logic part dynamic current consumption ${ }^{\text {Notes4,5 }}$ | IDD1 | Vod1, when with no load |  |  | 0.5 | 3.5 | mA |
| Driver part dynamic current consumption ${ }^{\text {Notes4,5 }}$ | IdD2 | Vod2, when with no load |  |  | 2.2 | 8.0 | mA |

Notes 1. Vx refers to the output voltage of analog output pins $S_{1}$ to $S_{300}$.
Vout refers to the voltage applied to analog output pins $\mathrm{S}_{1}$ to $\mathrm{S}_{300}$.
2. The output voltage deviation refers to the voltage difference between adjoining output pins when the display data is the same (within the chip).
3. The average output voltage variation refers to the average output voltage difference between chips. The average output voltage refers to the average voltage between chips when the display data is the same.
4. The STB cycle is defined to be $20 \mu \mathrm{~s}$ at fcLk $=40 \mathrm{MHz}$. The TYP. values refer to an all black or all white input pattern. The MAX. value refers to the measured values in the dot checkerboard input pattern.
5. Refers to the current consumption per driver when cascades are connected under the assumption of SVGA single-sided mounting (10 units).

Switching Characteristics ( $\mathrm{T}_{\mathrm{A}}=-10$ to $+75^{\circ} \mathrm{C}, \mathrm{VdD1}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}, \mathrm{VdD2}=8.0 \mathrm{~V} \pm 0.5 \mathrm{~V}, \mathrm{Vss} 1=\mathrm{Vss}^{2}=0 \mathrm{~V}$ )

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Start pulse delay time | tpLH1 | $\mathrm{CL}_{\mathrm{L}}=25 \mathrm{pF}$ |  | 13 | 20 | ns |
| Driver output delay time | tPHL2 | $C L=125 \mathrm{pF}, \mathrm{RL}=4 \mathrm{k} \Omega^{\text {Nole }}$ |  | 3.7 | 8 | $\mu \mathrm{s}$ |
|  | tphl3 |  |  | 5.3 | 14 | $\mu \mathrm{s}$ |
|  | tpLH2 |  |  | 3.0 | 8 | $\mu \mathrm{s}$ |
|  | tpLH3 |  |  | 5.3 | 14 | $\mu \mathrm{s}$ |
| Input capacitance | $\mathrm{C}_{1}$ | STHR,STHL excluded, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 5.4 | 15 | pF |
|  | $\mathrm{C}_{2}$ |  |  | 7.6 | 15 | pF |

Note Load condition


Timing Requirements ( $\mathrm{T}_{\mathrm{A}}=-10$ to $+75^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD} 1}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{ss} 1}=\mathrm{V}_{\mathrm{ss} 2}=0 \mathrm{~V}, \mathrm{tr}_{\mathrm{t}}=\mathrm{tf}_{\mathrm{f}}=8.0 \mathrm{~ns}$ )

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Clock pulse width | PWclk |  | 25 |  |  | ns |
| Clock pulse low period | PWсıк (L) |  | 6 |  |  | ns |
| Clock pulse high period | PWCLK (H) |  | 6 |  |  | ns |
| Data setup time | tsetup 1 |  | 6 |  |  | ns |
| Data hold time | thold |  | 6 |  |  | ns |
| Start pulse setup time | tsetup2 |  | 5 |  |  | ns |
| Start pulse hold time | thold 2 |  | 5 |  |  | ns |
| Start pulse low period | tspL |  | 6 |  |  | ns |
| POL2 setup time | tsetup 3 |  | 6 |  |  | ns |
| POL2 hold time | thold3 |  | 6 |  |  | ns |
| STB pulse width | PWstb |  | 1 |  |  | $\mu \mathrm{s}$ |
| Data invalid period | tinv |  | 1 |  |  | CLK |
| Final data timing | tLDT |  | 2 |  |  | CLK |
| CLK-STB time | tcles-stb | CLK $\uparrow \rightarrow$ STB $\uparrow$ | 6 |  |  | ns |
| STB-CLK time | tste-clk | STB $\uparrow \rightarrow$ CLK $\uparrow$ | 6 |  |  | ns |
| Time between STB and start pulse | tstb-sth | STB $\downarrow \rightarrow$ CLK $\uparrow$ | 60 |  |  | ns |
| POL-STB time | tpoL-stb | POL¢or $\downarrow \rightarrow$ STB $\uparrow$ | -5 |  |  | ns |
| STB-POL time | tstb-poL | STB $\downarrow \rightarrow$ POL $\uparrow$ or $\downarrow$ | 6 |  |  | ns |



## 12. RECOMMENDED MOUNTING CONDITIONS

The following conditions must be met for mounting conditions of the $\mu$ PD16634A.
For more details, refer to the Semiconductor Device Mounting Technology Manual(C10535E).
Please consult with our sales offices in case other mounting process is used, or in case the mounting is done under different conditions.
$\mu$ PD16634AN-xxx : TCP(TAB Package)

| Mounting Condition | Mounting Method | Condition |
| :--- | :--- | :--- |
| Thermocompression | Soldering | Heating tool 300 to $350^{\circ} \mathrm{C}$, heating for 2 to $3 \mathrm{sec} ;$ pressure 100 g (per <br> solder) |
|  | ACF | Temporary bonding 70 to $100^{\circ} \mathrm{C}$; pressure 3 to $8 \mathrm{~kg} / \mathrm{cm}^{2} ;$ time 3 to 5 <br> (Adhesive Conductive <br> sec. Real bonding 165 to $180^{\circ} \mathrm{C}$ pressure 25 to $45 \mathrm{~kg} / \mathrm{cm}^{2}$ time 30 to <br> Film) |
|  |  |  |

Caution To find out the detailed conditions for mounting the ACF part, please contact the ACF manufacturing company. Be sure to avoid using two or more mounting methods at a time.
[MEMO]
[MEMO]

## NOTES FOR CMOS DEVICES

## (1) PRECAUTION AGAINST ESD FOR SEMICONDUCTORS

Note:
Strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred. Environmental control must be adequate. When it is dry, humidifier should be used. It is recommended to avoid using insulators that easily build static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work bench and floor should be grounded. The operator should be grounded using wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with semiconductor devices on it.

## (2) HANDLING OF UNUSED INPUT PINS FOR CMOS

Note:
No connection for CMOS device inputs can be cause of malfunction. If no connection is provided to the input pins, it is possible that an internal input level may be generated due to noise, etc., hence causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using a pull-up or pull-down circuitry. Each unused pin should be connected to VDD or GND with a resistor, if it is considered to have a possibility of being an output pin. All handling related to the unused pins must be judged device by device and related specifications governing the devices.
(3) STATUS BEFORE INITIALIZATION OF MOS DEVICES

Note:
Power-on does not necessarily define initial status of MOS device. Production process of MOS does not define the initial operation status of the device. Immediately after the power source is turned ON, the devices with reset function have not yet been initialized. Hence, power-on does not guarantee out-pin levels, I/O settings or contents of registers. Device is not initialized until the reset signal is received. Reset operation must be executed immediately after power-on for devices having reset function.

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"Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.

Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
Specific: Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.
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